

Part Number: AM27SURCK09

Hyper Red

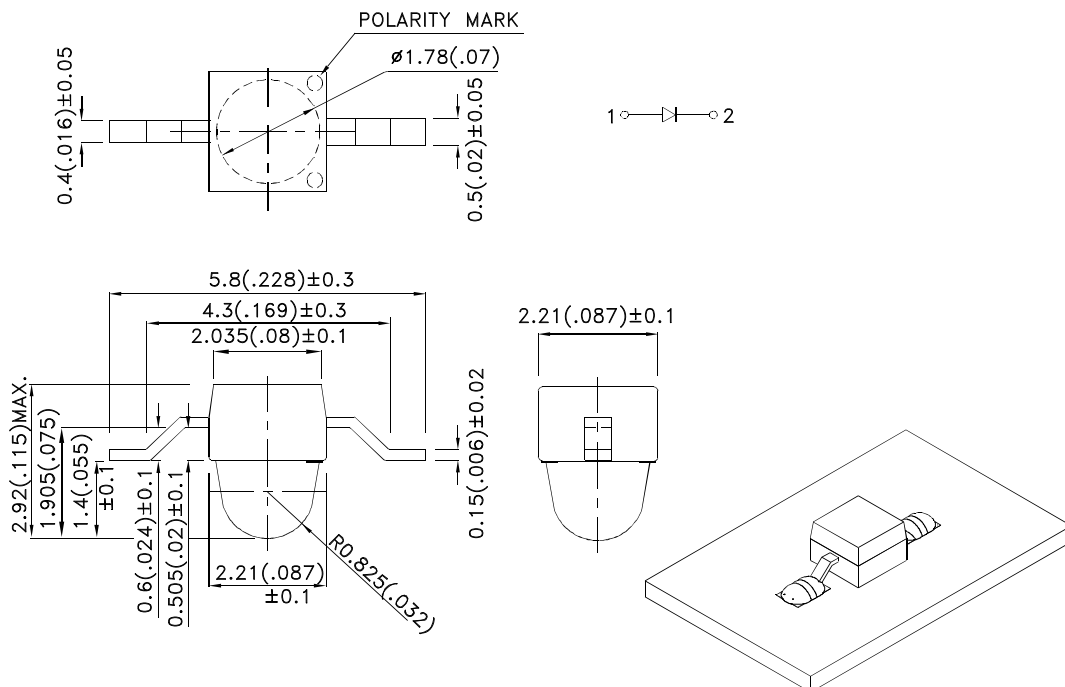
Features

- Subminiature package.
- Z-Bend lead.
- Long life - solid state reliability.
- Low package profile.
- Package :1000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaN on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
5. The device has a single mounting surface. The device must be mounted according to the specifications.



Selection Guide

| Part No. | Dice | Lens Type | Iv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|-------------|---------------------|-------------|------------------------|------|----------------------|
| | | | Min. | Typ. | 2θ1/2 |
| AM27SURCK09 | Hyper Red (AlGaInP) | Water Clear | 1500 | 2400 | 20° |

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|--------------------|--------------------------|-----------|------|------|-------|---------------------------|
| λ _{peak} | Peak Wavelength | Hyper Red | 650 | | nm | I _F =20mA |
| λ _D [1] | Dominant Wavelength | Hyper Red | 630 | | nm | I _F =20mA |
| Δλ _{1/2} | Spectral Line Half-width | Hyper Red | 28 | | nm | I _F =20mA |
| C | Capacitance | Hyper Red | 35 | | pF | V _F =0V;f=1MHz |
| V _F [2] | Forward Voltage | Hyper Red | 1.95 | 2.5 | V | I _F =20mA |
| I _R | Reverse Current | Hyper Red | | 10 | uA | V _R =5V |

Notes:

1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

| Parameter | Hyper Red | Units |
|--------------------------|----------------|-------|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 185 | mA |
| Reverse Voltage | 5 | V |
| Operating Temperature | -40°C To +85°C | |
| Storage Temperature | -40°C To +85°C | |

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



Hyper Red

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Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

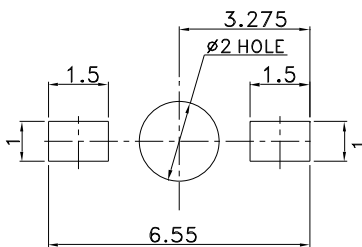
Reflow Soldering Profile For Lead-free SMT Process.



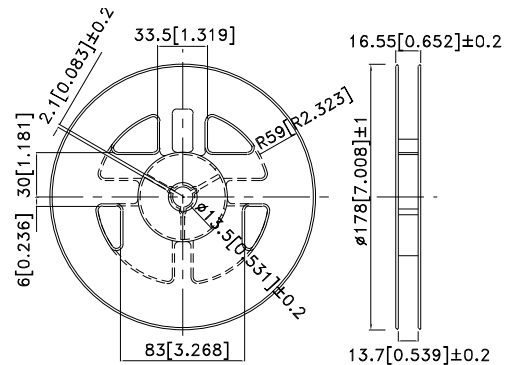
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

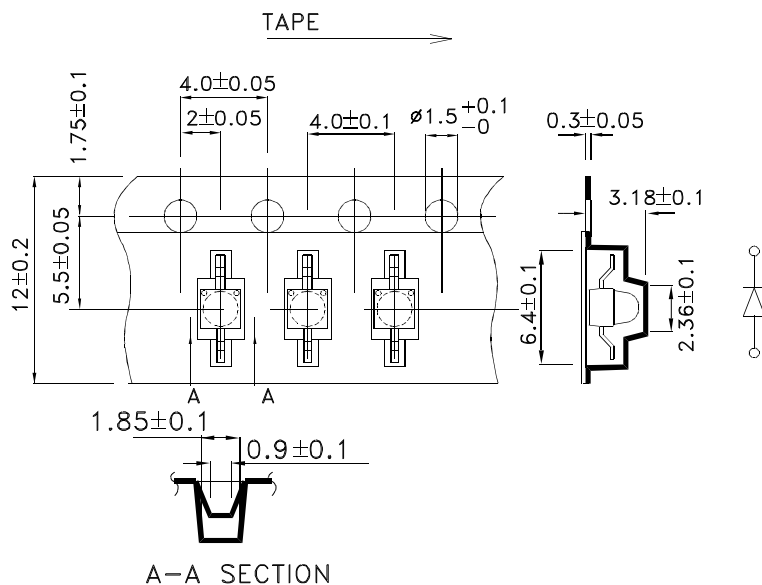
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



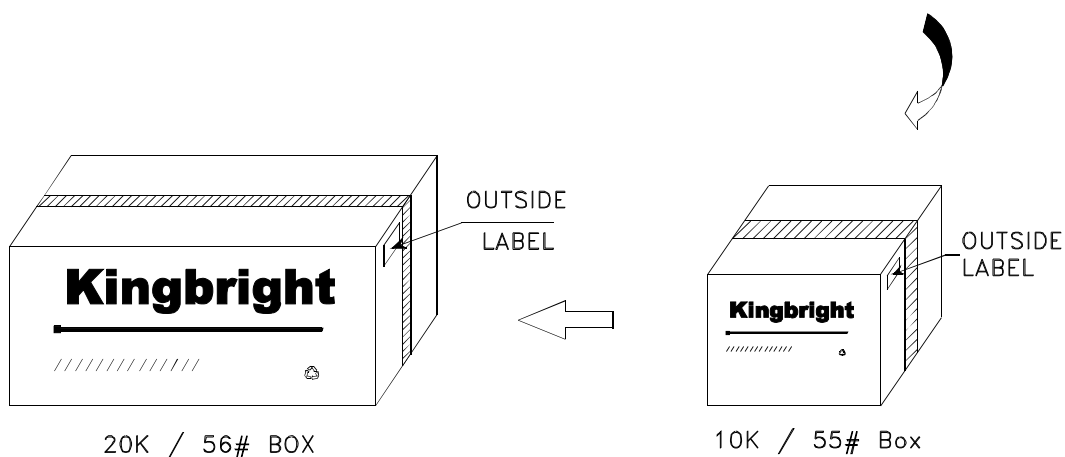
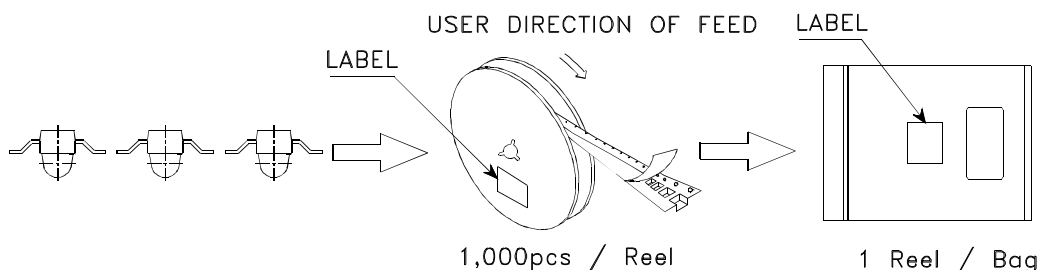
Tape Dimensions (Units : mm)




Kingbright

PACKING & LABEL SPECIFICATIONS

AM27SURCK09



| | |
|---|--|
| <h1>Kingbright</h1> | |
| P/NO: AM27xxx09 | |
| QTY: 1,000 pcs | Q.C. Q C XX XX XXXX PASSED |
| S/N: XXXX | |
| CODE: XXX | |
| LOT NO: | |
|  <small>XXXXXXXXXXXXXXXXXXXXXXXXXXXX</small> | |
| RoHS Compliant | |